



CHIP RESISTOR AND METHOD FOR PRODUCING THE SAME**Publication number:** WO2004010440**Publication date:** 2004-01-29**Inventor:** TSUKADA TORAYUKI (JP)**Applicant:** ROHM CO LTD (JP); TSUKADA TORAYUKI (JP)**Classification:**






- International: H01C1/144; H01C7/00; H01C17/00; H01C17/28;
H05K3/34; H01C1/14; H01C7/00; H01C17/00;
H01C17/28; H05K3/34; (IPC1-7): H01C7/00; H01C17/02

- european: H01C1/144; H01C7/00D; H01C17/00F; H01C17/28B

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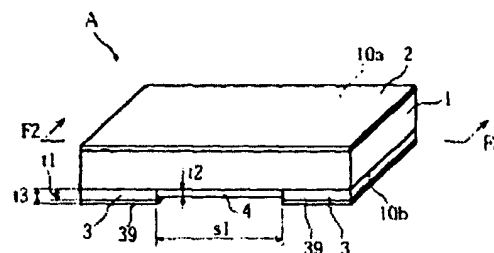
 US2005266615 (A)
 CN1672222 (A)

Cited documents:

 JP2002057009
 JP6215908
 JP7029704
 JP60049611
 US6261927
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A chip resistor comprising a resistor (1), an insulating layer (4) formed on the back of the resistor, and two electrodes (3) spaced apart from each other via the insulating layer. Each electrode (3) abuts against the insulating layer (4). A solder layer (39) is formed on the lower surface of each electrode (3).

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